Overview

HP ProBook 445 14" G9 Notebook PC



Left

- 1. Internal Microphones (2)
- 2. Webcam LED (optional)
- 3. Camera Shutter
- 4. Combo Web/IR Camera (Optional)
- 5. Clickpad
- 6. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 7. Ethernet Port (RJ-45)
- 8. Nano Security Lock Slot (Lock sold separately)



Overview



Right

- **1.** Power Button Key
- 2. Power Connector
- **3.** SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
- 4. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 5. SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
- 6. HDMI 2.0b Port (Cable not included)
- 7. Audio Combo Jack
- 8. Nano SIM Slot (Select Models)
- 9.

Touch Fingerprint Sensor (Select Models)



Overview

AT A GLANCE

- Preinstalled with Windows 11 versions or FreeDOS
- Choice of AMD Barcelo™ 5000 series mobile processors, R7, R5 and R3
- Integrated AMD Radeon [™] Vega graphics
- Fast and upgradeable dual channel DDR4 SODIMM memory up to 32 GB
- Choice of 35.56 cm (14.0") diagonal HD, Ultra Wide Viewing Angle FHD, FHD Touch Screen and privacy panel option
- Features redesigned quiet and responsive HP Keyboard with the HP Programmable key and backlit options
- Choice of primary solid state drives up to 1TB, 2nd SSD 128GB/256GB (Optional)
- Multi-layered security with HP SureStart Gen6, HP Privacy Camera, HP Sure View Gen4, HP Sure Sense G2, HP Sure Click, and Touch Fingerprint reader, Tamper Lock, HP Wolf Security
- Supports wireless options for connectivity on the go including gigabit-speed up to Wi-Fi 6E and CAT9 4G/LTE WWAN (Optional)
- Supports fast charging (50% in 30 minutes) with no impact on battery recharge cycles
- Designed to support HP docking options including the HP Universal Dock G5
- Undergoes 19 MIL-STD 810H tests
- Battery options 42.75 Wh and 51.3 Wh
- Battery life up to 20 hours and 30 minutes
- Optimize your video calls with an HD camera and temporal noise reduction that adjusts to the lighting in your environment.

NOTE: See important legal disclosures for all listed specs in their respective features sections.

PRODUCT NAME

HP ProBook 445 14" G9 Notebook PC

OPERATING SYSTEM

 Preinstalled
 Windows 11 Pro 1

 Windows 11 Pro Education 1
 Windows 11 Pro Education 1

 Windows 11 Home - HP recommends Windows 11 Pro for business 1
 Windows 11 Home Single Language - HP recommends Windows 11 Pro for business 1

 Windows 11 Pro (Windows 11 Enterprise or Windows 10 Enterprise available with a Volume Licensing Agreement) 1
 Windows 11 Pro (preinstalled with Windows 10 Pro Downgrade) 1.2

 FreeDOS
 FreeDOS

1. Not all features are available in all editions or versions of Windows. Systems may require upgraded and/or separately purchased hardware, drivers, software or BIOS update to take full advantage of Windows functionality. Windows is automatically updated and enabled. High speed internet and Microsoft account required. ISP fees may apply and additional requirements may apply over time for updates. See http://www.windows.com.

2. This system is preinstalled with Windows 10 Pro software and also comes with a license for Windows 11 Pro software and provision for recovery software. You may only use one version of the Windows software at a time. Switching between versions will require you to uninstall one version and install the other version. You must back up all data (files, photos, etc.) before uninstalling and installing operating systems to avoid loss of your data.

PROCESSORS

AMD Ryzen[™] 7 5825U Mobile Processor with Radeon[™] Graphics (2.0 GHz base clock, up to 4.5 GHz max boost clock, 16 MB L3 cache, 8 cores, 16 threads) ^{3,4,5,6}

AMD Ryzen[™] 5 5625U Mobile Processor with Radeon[™] Graphics (2.3 GHz base clock, up to 4.3 GHz max boost clock, 16 MB L3 cache, 6 cores, 12 threads) ^{3,4,5,6}

AMD Ryzen[™] 3 5425U Mobile Processor with Radeon[™] Graphics (2.7 GHz base clock, up to 4.1 GHz max boost clock, 8 MB L3 cache, 4 cores, 8 threads) ^{3,4,5,6}

Processor Family

AMD Barcelo[™] 5000 Series Mobile Processors ⁶

Processor speed denotes maximum performance mode; processors will run at lower speeds in battery optimization mode.
 Multicore is designed to improve performance of certain software products. Not all customers or software applications will necessarily benefit from use of this technology. Performance and clock frequency will vary depending on application workload and your hardware and software configurations. AMD's numbering is not a measurement of clock speed.

5. AMD Max Burst frequency performance varies depending on hardware, software and overall system configuration.

6. In accordance with Microsoft's support policy, HP does not support the Windows 8 or Windows 7 operating system on products configured with Intel and AMD 7th generation and forward processors or provide any Windows 8 or Windows 7 drivers on http://www.support.hp.com.



CHIPSET

Chipset is integrated with processor

GRAPHICS

Integrated

AMD Radeon™ Graphics ⁷

Supports

Support HD decode, DX12, HDMI 1.4

7. HD content required to view HD images.

DISPLAY

Non-Touch

35.6 cm (14") diagonal FHD, Low Blue Light UWVA eDP+ PSR anti-glare, with HP Sure View Reflect Gen3 Integrated Privacy Screen 1000 nits, 100% sRGB for HD+IR camera (1920 x 1080) with HP Eye Ease ^{7,8,9}

35.6 cm (14") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 400 nits, 100% sRGB for HD camera (1920 x 1080) ^{7,8} 35.6 cm (14") diagonal FHD UWVA eDP anti-glare, low power narrow bezel bent, 400 nits, 72% NTSC for HD Webcam+ IR camera (1920 x 1080) ^{7,8}

35.6 cm (14") diagonal FHD UWVA eDP w/o PSR anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD camera +WWAN (1920 x 1080) ^{7,8}

35.6 cm (14") diagonal FHD UWVA eDP w/o PSR anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1920 x 1080)^{7,8} 35.6 cm (14") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD Webcam (1920 x 1080)^{7,8} 35.6 cm (14") diagonal FHD UWVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD Webcam+ IR camera (1920 x 1080)^{7,8}

35.6 cm (14") diagonal HD SVA eDP w/o PSR anti-glare, narrow bezel bent, 250 nits, 45% NTSC (1366 x 768) ^{7,8} 35.6 cm (14") diagonal HD eDP w/o PSR anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD camera +WWAN (1366 x 768) ^{7,8}

35.6 cm (14") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD Webcam (1366 x 768) ^{7,8} 35.6 cm (14") diagonal HD SVA eDP anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD Webcam+ IR camera (1366 x 768) ^{7,8}

Touch

35.6 cm (14") diagonal FHD, touch, UWVA eDP w/o PSR anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD IR camera (1920 x 1080) ^{7,8,10}

35.6 cm (14") diagonal FHD, touch, UWVA eDP w/o PSR anti-glare, narrow bezel bent, 250 nits, 45% NTSC for HD IRcamera +WWAN (1920 x 1080) ^{7,8,10}

HDMI

Support resolutions up to 4k 60Hz

Display Size

14" 35.6 cm (14") Diagonal



Technical Specifications

7. HD content required to view HD images.

8. Resolutions are dependent upon monitor capability, and resolution and color depth settings.

9. HP Sure View integrated privacy screen is an optional feature that must be configured at purchase and is designed to function in landscape orientation.

10. Actual brightness will be lower with touch or HP Sure View

DOCKING (Sold Separately)

Docking station model #1 Docking station model #2 Docking station model #3 HP Thunderbolt Dock G2 HP USB-C Dock G5 HP USB-C/A Universal Dock G2

For additional aftermarket options and docking specs please see page 37.

STORAGE AND DRIVES

Primary Storage

128 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹¹ 256 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹¹ 512 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹¹ 1 TB PCIe[®] NVMe[™] M.2 TLC Solid State Drive ¹¹

Secondary M.2 Storage (Optional)

128 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹¹ 256 GB PCIe[®] NVMe[™] M.2 Value Solid State Drive ¹¹

11. For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB (for Windows) is reserved for system recovery software.

MEMORY

Maximum Memory 32 GB DDR4-3200 SDRAM ¹²

Memory

32 GB DDR4-3200 SDRAM (2 x 16 GB) ¹² 16 GB DDR4-3200 SDRAM (1 x 16 GB) ¹² 16 GB DDR4-3200 SDRAM (2 x 8 GB) ¹² 12 GB DDR4- 3200 SDRAM (4 GB and 8 GB (1 x 8 GB)) ¹² 8 GB DDR4-3200 SDRAM (1 x 8 GB) ¹² 8 GB DDR4-3200 SDRAM (2 x 4 GB) ¹² 4 GB DDR4-3200 SDRAM (1 x 4 GB) ¹²

Memory Slots

2 SODIMM



Technical Specifications

Both slots are accessible/upgradeable by IT or self-maintainers only DDR4 PC4 SODIMMS, system runs at 3200 Supports Dual Channel Memory

12. Due to the non-industry standard nature of some third-party memory modules, we recommend HP branded memory to ensure compatibility. If you mix memory speeds, the system will perform at the lower memory speed.

NETWORKING/COMMUNICATIONS

WLAN

Realtek RTL8852BE 802.11ax 2x2 Wi-Fi[®] + Bluetooth[®] 5.3 ¹³ Qualcomm[®] Fast Connect 6900 Wi-Fi 6E + Bluetooth[®] 5.3 (802.11ax 2x2, AMD AIM-T AME) ^{13,14}

WWAN

Intel[®] XMM[™] 7560 R+ LTE-Advanced Pro Cat 16 ^{13, 15}

Miracast

Native Miracast Support

Ethernet

Realtek RTL8111HSH 10/100/1000 Integrated NIC ¹⁶

Wake on WLAN

Support on S3 AC mode only

13. Wireless access point and internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 is backwards compatible with prior 802.11 specs.

14. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported.

15. WWAN is an optional feature, requires factory configuration and separately purchased service contract. Check with service provider for coverage and availability in your area. 4G LTE not available on all products, in all regions.

16. The term "10/100/1000" or "Gigabit" Ethernet indicates compatibility with IEEE standard 802.3ab for Gigabit Ethernet, and does not connote actual operating speed of 1 Gb/s. For high-speed transmission, connection to a Gigabit Ethernet server and network infrastructure is required.



AUDIO/MULTIMEDIA

Audio

2 Integrated stereo speakers Integrated microphone (Dual Array)

Speaker Power

2W/4ohm per speaker

Camera

720p HD camera with Temporal Noise Reduction ⁷ 720p HD camera+IR Camera ^{7,17}

7. HD content required to view HD images. 17. Sold separately or as an optional feature.

KEYBOARDS/POINTING DEVICES/BUTTONS & FUNCTION KEYS

Keyboard

HP Premium Keyboard, spill resistant and optional Durakeys and backlit

Pointing Device Clickpad with multi-touch gesture support

Function Keys

- F1 Display Switching
- F2 Blank or SureView On/Off
- F3 Brightness Down
- F4 Brightness Up
- F5 Audio Mute
- F6 Volume Down
- F7 Volume Up
- F8 Mic Mute
- F9 Blank or Backlit Toggle
- F10 Insert
- F11 Airplane Mode
- F12 Programmable key

Print Screen

Power Button (with LED)

Hidden Function Keys

Fn+R - Break Fn+S - Sys Rq Fn+C - Scroll Lock



SOFTWARE AND SECURITY

Software

HP Quick Drop ¹⁸ HP PC Hardware Diagnostics Windows HSA Fusion for Commercial HSA Telemetry for Commercial Touchpoint Customizer for Commercial myHP HP Smart Support ¹⁹ HP Connection Optimizer HP Hotkey Support HP Support Assistant ²⁰ HP Notifications HP Power Manager HP Privacy Settings Buy Microsoft Office (Sold separately)

Manageability Features

Manageability Features HP Connect for Microsoft Endpoint Manager²¹ HP Image Assistant Gen5 (download) HP Manageability Integration Kit (download)²² HP Client Management Script Library (download) HP Patch Assistant (download)²³ HP Driver Packs (download) HP Client Catalog (download)

Security Management

HP Wolf Security of Business²⁴ includes: HP Sure Click ²⁵ HP Sure Sense 2 ²⁶ HP Sure Start Gen7 ²⁷ HP Tamper Lock HP Sure Admin ²⁸ HP Client Security Manager Gen7 ²⁹

BIOS

HP BIOSphere Gen6 ³⁰ HP Secure Erase ³¹ Absolute Persistence Module ³² HP DriveLock & Automatic DriveLock BIOS Update via Network HP Wake on WLANTPM 2.0 Embedded Security Chip (Common Criteria EAL4+ Certified) (FIPS 140-2 Level 2 Certified) HP Fingerprint Sensor ³³

Security

TPM Model: Nuvoton NPCT760HAAYX Version: 7.2.3.0



Revision: TPM 2.0 FIPS 140-2 Compliant: Yes

IPv6 Support TBC

FirstNet Certified

No

Is the BIOS on this notebook ISO/IEC 19678:2015 (formerly NIST 800-147) compliant?: Yes

UEFI version: 2.7 Class: 3

18. HP Quick Drop requires Internet access and Windows 10 or higher PC preinstalled with HP QuickDrop app and either an Android device (phone or tablet) running Android 7 or higher with the Android HP QuickDrop app, and /or an iOS device (phone or tablet) running iOS 12 or higher with the iOS HP QuickDrop app.

19. HP Smart Support automatically collects the telemetry necessary upon initial boot of the product to deliver device-level configuration data and health insights and is available preinstalled on select products, thru HP Factory Configuration Services; or it can be downloaded. For more information about how to enable HP Smart Support or for download, please visit http://www.hp.com/smart-support.

20. HP Support Assistant requires Windows and Internet Access

21. HP Connect for Microsoft Endpoint Manager is available from the Azure Market Place for HP Pro, Elite, Z and Point-of-Sale PCs managed with Microsoft Endpoint Manager. Subscription to Microsoft Endpoint Manager required and sold separately. Network connection required

22. HP Manageability Integration Kit can be downloaded from http://www.hp.com/go/clientmanagement.

23. HP Patch Assistant available on select HP PCs with the HP Manageability Kit that are managed through Microsoft System Center Configuration Manager. HP Manageability Integration Kit can be downloaded from

http://www8.hp.com/us/en/ads/clientmanagement/overview.html.

24. HP Wolf Security for Business requires Windows 10 or higher, includes various HP security features and is available on HP Pro, Elite, RPOS and Workstation products. See product details for included security features and OS requirement.

25. HP Sure Click requires Windows 10 Pro or higher or Enterprise. See https://bit.ly/2PrLT6A_SureClick for complete details.

26. HP Sure Sense is available on select HP PCs with Windows 10 Pro, Windows 10 Enterprise, Windows 11 Pro, or Windows 11 Enterprise OS.

27. HP Sure Start Gen7 is available on select HP PCs and requires Windows 10 and higher

28. HP Sure Admin requires Windows 10 or higher, HP BIOS, HP Manageability Integration Kit from

http://www.hp.com/go/clientmanagement and HP Sure Admin Local Access Authenticator smartphone app from the Android or Apple store.

29. HP Client Security Manager Gen7 requires Windows and is available on the select HP Elite and Pro PCs

30. HP BIOSphere Gen6 features may vary depending on the platform and configuration.

31. For the methods outlined in the National Institute of Standards and Technology Special Publication 800-88 "Clear" sanitation method. HP Secure Erase does not support platforms with Intel[®] Optane™.

32. Absolute firmware module is shipped turned off and can only be activated with the purchase a license subscription and full activation of the software agent. License subscriptions can be purchased for terms ranging multiple years. Service is limited, check with Absolute for availability outside the U.S. Certain conditions apply. For full details visit: https://www.absolute.com/about/legal/agreements/absolute/.

33. HP Fingerprint sensor is an optional feature that must be configured at purchase.



POWER

Power Supply

HP Smart 65 W EM External AC power adapter ³⁴ HP Smart 65 W USB Type-C adapter ³⁴ HP Smart 45 W External AC power adapter ³⁴ HP Smart 45 W USB Type-C adapter ³⁴ HP Smart 65 W External AC power adapter ³⁴

Battery

HP Long Life 3-cell, 42.75 Wh Polymer ^{35,36} HP Long Life 3-cell, 51.3 Wh Polymer ^{35,36} Compliant with UL 1642 Standard

Power Cord

2-wire plug - 1m 3-wire plug - 1m

Battery life

Up to 20 hours and 30 minutes with 51 whr battery (HP Long Life 3-Cell, 51 Whr Polymer, UMA graphic, AMD R7, 200 nits display, 8G memory, 256 GB SSD) ³⁷

Up to 17 hours and 30 minutes with 42whr battery (HP Long Life 3-Cell, 42 Whr Polymer, UMA graphic, AMD R7, 200 nits display, 8G memory, 256 GB SSD)³⁷

34. Availability may vary by country.

35. Battery is internal and not replaceable by customer. Serviceable by warranty.

36. Actual battery Watt-hours (Wh) will vary from design capacity. Battery capacity will naturally decrease with shelf life, time, usage, environment, temperature, system configuration, loaded apps, features, power management settings and other factors.

37. Windows 10 MM18 battery life will vary depending on various factors including product model, configuration, loaded applications, features, use, wireless functionality, and power management settings. The maximum capacity of the battery will naturally decrease with time and usage. See http://www.bapco.com for additional details.



WEIGHTS & DIMENSIONS

Product Weight 42.75Wh Starting at 3.03 lb4³⁸ Starting at 1.38 kg ³⁸

51.3 Wh Starting at 3.14 lb ³⁸ Starting at 1.42 kg ³⁸

Product Dimensions (W x D x H)

12.67 x 8.42 x 0.78 in 32.19 x 21.39 x 1.99 cm

38. Weight will vary by configuration.

PORTS/SLOTS

SuperSpeed USB Type-C[®] 10Gbps signaling rate (USB Power Delivery, DisplayPort[™] 1.4)
 SuperSpeed USB Type-A 5Gbps signaling rate port (USB 3.2 Gen 1)
 HDMI 2.0b ³⁹
 RJ-45
 Headphone/microphone combo jack
 AC power
 Nano SIM slot for WWAN (optional)

39. HDMI cable sold separately.



SERVICE AND SUPPORT

HP Services offers 1-year or 3-year limited warranties and 90 day software limited warranty options depending on country. Batteries have a default one year limited warranty except for Long Life batteries which will have same 1-year or 3-year limited warranty as the platform. Refer to http://www.hp.com/support/batterywarranty/ for additional battery information. On-site service and extended coverage is also available. HP Care Pack Services are optional extended service contracts that go beyond the standard limited warranties. To choose the right level of service for your HP product, use the HP Care Pack Services Lookup Tool at: http://www.hp.com/go/cpc.⁴⁰

40. HP Care Packs are sold separately. Service levels and response times for HP Care Packs may vary depending on your geographic location. Service starts on date of hardware purchase. Restrictions and limitations apply. For details, visit http://www.hp.com/go/cpc. HP services are governed by the applicable HP terms and conditions of service provided or indicated to Customer at the time of purchase. Customer may have additional statutory rights according to applicable local laws, and such rights are not in any way affected by the HP terms and conditions of service or the HP Limited Warranty provided with your HP Product.



SYSTEM UNIT

Stand-Alone Power Requirements (AC Power)	
Nominal Operating Voltage	19V
Average Operating Power	7.52W (Idle)
Integrated graphics	Yes
Discrete Graphics	N/A
Max Operating Power	Discrete < 65W
	UMA < 45W
Temperature	
Operating	32° to 95° F (0° to 35° C)
Non-operating	-4° to 140° F (-20° to 60° C)
tion operating	
Relative Humidity	
Operating	10% to 90%, non-condensing
Non-operating	5% to 95%, 101.6° F (38.7° C) maximum wet bulb temperature
Shock	
Operating	40 G, 2 ms, half-sine
Non-operating	200 G, 2 ms, half-sine
Random Vibration	
Operating	1.043 grams
Non-operating	3.5 grams
Altitude (unpressurized)	
Operating	-50 to 10,000 ft (-15 to 3,048 m)
Non-operating	-50 to 40,000 ft (-15 to 12,192 m)
Planned Industry Standard Certifications	
Regulatory Model Number	HSN-Q34C-4
UL	Yes
CSA	Yes
FCC Compliance	Yes
	Yes ⁴¹
EPEAT®	EPEAT [®] 2019 Gold in the United States ⁴²
ICES	Yes
Australia /	Yes
NZ A-Tick Compliance	Yes
CCC	Yes
Japan VCCI Compliance	Yes
КС	Yes
BSMI	Yes
CE Marking Compliance	Yes
BNCI or BELUS	Yes
CIT	Yes
EAC	Yes
Saudi Arabian Compliance (ICCP)	Yes
SABS	Yes

Technical Specifications

UKRSERTCOMPUTER

Yes

41. Configurations of the HP ProBook 445 G9 that are ENERGY STAR[®] certified are identified as HP ProBook 445 G9 ENERGY STAR on HP websites and on http://www.energystar.gov.

42. Based on US EPEAT[®] registration according to IEEE 1680.1-2018 EPEAT[®]. EPEAT[®] status varies by country. Visit http://www.epeat.net for more information.

DISPLAYS

NOTE: All specifications represent the typical specifications provided by hp's component manufacturers; actual performance may vary either higher or lower.

1. Actual brightness will be lower with touchscreen or HP Sure View.

14.0 in FHD (1920 x 1080)	Outline Dimensions (W x H)	314.612x 185.330 (max)
Anti-Glare UWVA Low Blue Light	Active Area	309.312 x 173.990 (typ)
sRGB NB2Y 1000 eDP 1.3+PSR	Weight	230 g
100 PrivacyG4 Plus bent LCD Panel	Diagonal Size	14
Panet	Thickness	2.2/3.9 (max)
	Interface	eDP 1.3
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	1500:1
	Refresh Rate	60 Hz
	Brightness	1000 nits
	Pixel Resolution - Format	1920 x1080 (FHD)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	sRGB 100%
	Color Depth	8
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	Yes
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	NA

Panel LCD 14 inch FHD
(1920 x 1080) Anti-Glare WLED
UWVA 45percent cg 250nits eDP
1.2 w/o PSR bent Touch on Panel
NWBZ

Outline Dimensions (W x H) Active Area Weight Diagonal Size Thickness Interface Surface Treatment Touch Enabled Contrast Ratio Refresh Rate Brightness

316.170 x 186.400 (max) 309.370 x 174.020 (typ) 305 g (max) 14.0 3.0 / 5.0 (max) eDP 1.2 Anti-Glare On-cell Yes¹ 600:1 (typ) 60 Hz 250 nits¹



i cennical opecinication		
	Pixel Resolution - Format	1920 x 1080 (FHD)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	NTSC 45%
	Color Depth	6 (Hi FRC w/ condition to enable)
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	Νο
	Power Consumption (W, EBL@	
	150nits max/ 200nits max)	2.30 (max)/ 2.80 (max)
Panel LCD 14 inch FHD	Outline Dimensions (W x H)	315.070 x 186.600 (max)
(1920 x 1080) Anti-Glare WLED	Active Area	309.370 X 174.020 (typ)
UWVA sRGB 100percent cg	Weight	200 g (max)
400nits eDP 1.4+PSR2 bent LP	Diagonal Size	14.0
NB2X	Thickness	2.0 /4.0 (max)
	Interface	eDP 1.4
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	1200:1 (typ)
	Refresh Rate	60 Hz
	Brightness	400 nits
	Pixel Resolution - Format	1920 x 1080 (FHD)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	sRGB 100%
	Color Depth	6
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.07 (max)/ 2.50 (max)
Panel LCD 14-in FHD	Outline Dimensions (W x H)	316.170 x 186.400 (max)
(1920 x 1080) Anti-Glare WLED	Active Area	309.370 x 174.020 (typ)
UWVA 45percent cg 250nits eDP	Weight	300 g (max)
1.2 w/o PSR NWBZ bent	Diagonal Size	14.0
	Thickness	3.0 / 5.0 (max)
	Interface	



eDP 1.2

No

60 Hz

250 nits

Anti-Glare

600:1 (typ)

Interface

Surface Treatment

Touch Enabled

Contrast Ratio

Refresh Rate

Brightness

•		
	Pixel Resolution - Format	1920 x 1080 (FHD)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	NTSC 45%
	Color Depth	6 (Hi FRC w/ condition to enable)
	Viewing Angle	UWVA 85/85/85/85
	Low Blue Light	No
	Power Consumption (W, EBL@ 150nits max/ 200nits max)	2.205 (max)/ 2.716 (max)
Panel LCD 14-in HD (1366 x 768)	Outline Dimensions (W x H)	316.110 x 186.370 (max)
Anti-Glare WLED SVA 45percent	Active Area	309.400 x 173.950 (typ)
cg 250nits eDP 1.2 w/o PSR NWBZ bent	Weight	300 g (max)
	Diagonal Size	14.0
	Thickness	3.0 / 5.0 (max)
	Interface	eDP 1.2
	Surface Treatment	Anti-Glare
	Touch Enabled	No
	Contrast Ratio	300:1 (typ)
	Refresh Rate	60 Hz
	Brightness	250 nits
	Pixel Resolution - Format	1366 x 768 (HD)
	Backlight	WLED
	Pixel Resolution	RGB
	Color Gamut Coverage	NTSC 45%
	Color Depth	6
	Viewing Angle	SVA 45/45/15/35
	Low Blue Light	No
	Power Consumption (W, EBL@	2.52 (max) / 2.86 (max)
	150nits max/ 200nits max)	



STORAGE AND DRIVES

For storage drives, GB = 1 billion bytes. TB = 1 trillion bytes. Actual formatted capacity is less. Up to 30GB (for Windows) is reserved for system recovery software.

for system recovery software.	Form Fostor	M
SSD 128GB 2230 PCIe NVMe Value	Form Factor	M.2 2230
	Capacity	128GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Weight	0.01 lb (5 g)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	Up to 2100 MB/s
	Maximum Sequential Write	Up to 1200 MB/s
	Logical Blocks	250069680
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite; TRIM; L1.2
SSD 256GB 2230 PCIe NVMe Value	Form Factor	M.2 2230
	Capacity	256 GB
	NAND Type	TLC
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface	PCIe NVMe Gen3
	Maximum Sequential Read	up to 2500 MB/s
	Maximum Sequential Write	up to 1300 MB/s
	Logical Blocks	500118192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	Pyrite; TRIM; L1.2
SSD 256GB 2280 PCIe NVMe Value	Form Factor	M.2 2280
350 25000 2200 F CIE NVME Value	Capacity	256GB
	NAND Type	Value
	Height	0.09 in (2.3 mm)
	Width	0.87 in (22 mm)
	Interface Maximum Communical David	PCIe NVMe Gen3
	Maximum Sequential Read	Up to 2900 MB/s
	Maximum Sequential Write	Up to 1400 MB/s
	Logical Blocks	500118192
	Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
	Features	ATA Security; TRIM; L1.2



SSD 512GB 2280 PCle NVMe ValueForm FactorM.2 2280Capacity512GBNAND TypeValueHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 3500 MB/sMaximum Sequential Writeup to 3000 MB/sLogical Blocks1000215216Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesTRIM; L1.2SSD 1TB 2280 PCle-4x4 NVMeForm FactorMAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3MAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/sMaximum Sequential ReadUp to 7,100 MB/sMaximum Sequential ReadUp to 7,200 MB/s	•		
NAND TypeValueHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 3500 MB/sMaximum Sequential Writeup to 3000 MB/sLogical Blocks1000215216Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesTRIM; L1.2SSD 1TB 2280 PCle-4x4 NVMeForm FactorMAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3MAND TypeAD TICHeight0.99 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s	SSD 512GB 2280 PCIe NVMe Value	Form Factor	M.2 2280
Height0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 3500 MB/sMaximum Sequential Writeup to 3000 MB/sLogical Blocks1000215216Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesTRIM; L1.2SSD 1TB 2280 PCle-4x4 NVMeForm FactorMAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3MAND Type3D TLCHeight0.97 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Capacity	512GB
Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp to 3500 MB/sMaximum Sequential Writeup to 3000 MB/sLogical Blocks1000215216Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesTRIM; L1.2SSD 1TB 2280 PCIe-4x4 NVMeForm FactorMAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		NAND Type	Value
InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 3500 MB/sMaximum Sequential Writeup to 3000 MB/sLogical Blocks1000215216Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesTRIM; L1.2SSD 1TB 2280 PCle-4x4 NVMeForm FactorMAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Height	0.09 in (2.3 mm)
Maximum Sequential ReadUp to 3500 MB/sMaximum Sequential Writeup to 3000 MB/sLogical Blocks1000215216Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesTRIM; L1.2SSD 1TB 2280 PCle-4x4 NVMeForm FactorM.2 2280Capacity1TBNAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Width	0.87 in (22 mm)
Maximum Sequential Write Logical Blocksup to 3000 MB/s 1000215216Operating Temperature Features32° to 158°F (0° to 70°C) [ambient temp]FeaturesTRIM; L1.2SSD 1TB 2280 PCIe-4x4 NVMe Three Layer CellForm FactorM.2 2280Capacity1TBNAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Interface	PCIe NVMe Gen3
Logical Blocks1000215216Operating Temperature Features32° to 158°F (0° to 70°C) [ambient temp]SSD 1TB 2280 PCle-4x4 NVMe Three Layer CellForm FactorM.2 2280Capacity1TBNAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Maximum Sequential Read	Up to 3500 MB/s
Operating Temperature Features32° to 158°F (0° to 70°C) [ambient temp] TRIM; L1.2SSD 1TB 2280 PCle-4x4 NVMe Three Layer CellForm FactorM.2 2280Capacity1TBNAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Maximum Sequential Write	up to 3000 MB/s
FeaturesTRIM; L1.2SSD 1TB 2280 PCIe-4x4 NVMe Three Layer CellForm FactorM.2 2280Capacity1TBNAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCIe NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Logical Blocks	1000215216
SSD 1TB 2280 PCle-4x4 NVMeForm FactorM.2 2280Three Layer CellCapacity1TBNAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Operating Temperature	32° to 158°F (0° to 70°C) [ambient temp]
Three Layer CellCapacity1TBNAND Type3D TLCHeight0.09 in (2.3 mm)Width0.87 in (22 mm)InterfacePCle NVMe Gen3Maximum Sequential ReadUp to 7,100 MB/s		Features	TRIM; L1.2
Logical Blocks2000409264Operating Temperature32° to 158°F (0° to 70°C) [ambient temp]FeaturesPyrite 2.0; TRIM; L1.2		Capacity NAND Type Height Width Interface Maximum Sequential Read Maximum Sequential Write Logical Blocks Operating Temperature	1TB 3D TLC 0.09 in (2.3 mm) 0.87 in (22 mm) PCIe NVMe Gen3 Up to 7,100 MB/s Up to 5,200 MB/s 2000409264 32° to 158°F (0° to 70°C) [ambient temp]

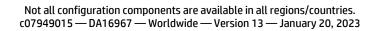
NETWORKING/COMMUNICATIONS

Qualcomm® Fast Connect 6900 Wi-Fi 6E + BT5.3 (802.11ax 2x2, AMD AIM- T AME, supporting gigabit file transfer speeds) ¹		IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11h IEEE 802.11k IEEE 802.11k IEEE 802.11r IEEE 802.11v IEEE 802.11v IEEE 802.11w
	Interoperability	Wi-Fi certified
	Frequency Band	•802.11b/g/n/ax 2.402 – 2.482 GHz •802.11a/n/ac/ax 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz 5.925 – 7.125 GHz"
	Data Rates	 802.11b: 1, 2, 5.5, 11 Mbps 802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps 802.11a: MCS 0 ~ MCS 15, (20MHz, and 40MHz) 802.11ac: MCS0 ~ MCS9, (1SS, and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz) 802.11ax: MCS0 ~ MCS11, (1SS and 2SS) (20MHz, 40MHz, ,80MHz & 160MHz)
	Modulation	Direct Sequence Spread Spectrum OFDM, BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM, 4096QAM
	Security ³	•AES-CCMP: 128 bit in hardware •802.1x authentication •WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. •WPA2 certification •IEEE 802.11i
	Network Architecture	Wi-Fi Direct in Win10 for peer-to-peer connection.
	Models	Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power ²	2.4GHz (MIMO, typical): • 802.11b: +18dBm • 802.11g: +16.5dBm • 802.11n/ac/ax (HT20/VHT20/HE20): +16dBm



hD

Technical Specifications 802.11n/ac/ax (HT40/VHT40/HE40): +12.5dBm 5GHz (MIMO, typical): • 802.11a: +13dBm 802.11n/ac/ax (HT20/VHT20/HE20): +13.5dBm • 802.11n/ac/ax (HT40/VHT40/HE40): +12.5dBm 802.11ac/ax (VHT80/HE80): +11.5dBm • 802.11ax HE160: +11.5dBm 6GHz LPI mode (MIMO. typical): 802.11a: 0dBm 802.11ax HE20: +1dBm 802.11ax HE40: +4dBm • 802.11ax HE80: +7dBm 802.11ax HE160: +7.5dBm " **Power Consumption** Transmit mode: 3.0 W Receive mode: 2.0 W Idle mode (WLAN associated): 300mW Idle mode (WLAN unassociated): 100mW Modern Connected Standby: 10mW Radio disabled: 8 mW ACPI and PCI Express compliant power management **Power Management** 802.11 compliant power saving mode **Receiver Sensitivity**⁴ 2.4GHz (SISO): •802.11b, 11Mbps: -82dBm maximum 802.11g, 54Mbps: -71dBm maximum 802.11n. MCS7: -64dBm maximum 802.11ac, MCS9: -52dBm maximum •802.11ax, MCS11(HT40): -49dBm maximum 5GHz (SISO): • 802.11a, 54Mbps: -71dBm maximum 802.11n, MCS07: -64dBm maximum 802.11ac, MCS9: -52dBm maximum •802.11ax, MCS11(HE80/HE160): -46dBm maximum 6GHz (SISO): • 802.11a, 54Mbps: -71dBm maximum 802.11n, MCS7: -64dBm maximum 802.11ac, MCS9: -52dBm maximum 802.11ax, MCS11(HE160): -46dBm maximum" Antenna type High efficiency antenna with spatial diversity, mounted in the display enclosure Two embedded dual band 2.4/5 GHz antennas are provided to the card to support WLAN MIMO communications and Bluetooth communications Form Factor PCI-Express M.2 MiniCard Dimensions Type 2230 : 2.3 x 22.0 x 30.0 mm Weight Type 2230 : 3g **Operating Voltage** 3.3 +/ 0.165v Temperature Operating -10° to 60° C Non-operating -40° to 85° C



	Humidity	Operating Non-operating	10% to 90% (non-condensing) 5% to 95% (non-condensing)
	Altitude	Operating	0 to 10,000 ft (3,048 m)
		Non-operating	0 to 50,000 ft (15,240 m)
	LED Activity	N/A	
HP Integrated Module wit	h Bluetooth 4.0/4.1/4.2/5.0	0/5.1/5.2/5.3 Wire	eless Technology
	Bluetooth Specification	4.0/4.1/4.2/5.0/	5.1/5.2/5.3 Compliant
	Frequency Band	2402 to 2480 MH	lz
	Number of Available Channels	Legacy: 0~79 (1 BLE: 0~39 (2 MH;	
	Data Rates and Throughput	BLE: 1 Mbps data Legacy: Synchron channels Legacy: Asynchro	lata rate; throughput up to 2.17 Mbps a rate; throughput up to 0.2 Mbps nous Connection Oriented links up to 3, 64 kbps, voice onous Connection Less links 2178.1 kbps/177.1 kbps H5) or 864 kbps symmetric (3-EV5)
	Transmit Power		omponent shall operate as a Class 1.5 Bluetooth device transmit power of + 14 dBm and 10 dBm for BR and EDR,

1. Wi-Fi 6E requires a Wi-Fi 6E router, sold separately, to function in the 6GHz band. Availability of public wireless access points limited. Wi-Fi 6E is backwards compatible with prior 802.11 specs. And available in countries where Wi-Fi 6E is supported. Wi-Fi 6E is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).



Realtek RTL8852BE 802.11ax 2x2 Wi-Fi® + BT5.3 (802.11ax 2x2, supporting gigabit data rate) ¹	Wireless LAN Standards	IEEE 802.11a IEEE 802.11b IEEE 802.11g IEEE 802.11n IEEE 802.11ac IEEE 802.11ax IEEE 802.11d IEEE 802.11d IEEE 802.11e IEEE 802.11h IEEE 802.11i IEEE 802.11i IEEE 802.11v
	Interoperability Frequency Band	Wi-Fi certified modules •802.11b/g/n/ax
	Data Rates	2.402 – 2.482 GHz •802.11a/n/ac/ax 4.9 – 4.95 GHz (Japan) 5.15 – 5.25 GHz 5.25 – 5.35 GHz 5.47 – 5.725 GHz 5.825 – 5.850 GHz •802.11b: 1, 2, 5.5, 11 Mbps •802.11g: 6, 9, 12, 18, 24, 36, 48, 54 Mbps
		•802.11a: 6, 9, 12, 18, 24, 36, 48, 54 Mbps •802.11n: max 300Mbps •802.11ac: max 866.7Mbps • 802.11ax: max 1201Mbps
	Modulation	Direct Sequence Spread Spectrum BPSK, QPSK, CCK, 16-QAM, 64-QAM, 256-QAM, 1024QAM
	Security ³	 IEEE and WiFi certified 64 / 128 bit WEP encryption for a/b/g mode only AES-CCMP: 128 bit in hardware 802.1x authentication WPA, WPA2: 802.1x. WPA-PSK, WPA2-PSK, TKIP, and AES. WPA2 certification WPA3 certification IEEE 802.11i WAPI
	Network Architecture Models	Ad-hoc (Peer to Peer) Infrastructure (Access Point Required)
	Roaming	IEEE 802.11 compliant roaming between access points
	Output Power ²	 802.11b : +18.5dBm minimum 802.11g : +17.5dBm minimum 802.11a : +18.5dBm minimum 802.11n HT20(2.4GHz) : +15.5dBm minimum 802.11n HT40(2.4GHz) : +14.5dBm minimum 802.11n HT20(5GHz) : +15.5dBm minimum



Technical Specifications

•			
			5GHz) : +14.5dBm minimum 80(5GHz) : +11.5dBm minimum
)(2.4GHz) : +10dBm minimum)(5GHz) : +10dBm minimum
	Power Consumption	• Transmit mode:	
		•Receive mode:2	
			180 mW(WLAN Associated)
			W(WLAN unassociated) Idby/Modern Standby: 10mW
		•Radio disabled:	
	Power Management	-	ress compliant power management It power saving mode
	Receiver Sensitivity⁴		: -93.5dBm maximum
	Receiver Sensitivity	•	s: -84dBm maximum
		•	os: -86dBm maximum
			ops: -72dBm maximum
			: -67dBm maximum : -64dBm maximum
			-84dBm maximum
			-59dBm maximum
			11(HE40): -57dBm maximum
	Antonna tupa		11(HE80): -54dBm maximum
	Antenna type	enclosure.	ntenna with spatial diversity, mounted in the display
			dual band 2.4/5 GHz antennas are provided to the card to
		support WLAN M	IMO communications and Bluetooth communications
	Form Factor	PCI-Express M.2	MiniCard
	Dimensions		3 x 22.0 x 30.0 mm
	Weight		67 x 12.0 x 16.0 mm
	Weight	1. Type 2230: 2.8 2. Type 126: 1.3	-
	Operating Voltage	3.3v +/- 9%	
	Temperature	Operating	14° to 158° F (–10° to 70° C)
		Non-operating	–40° to 176° F (–40° to 80° C)
	Humidity	Operating	10% to 90% (non-condensing)
	Altitude	Non-operating Operating	5% to 95% (non-condensing) 0 to 10,000 ft (3,048 m)
	Allitude	Non-operating	0 to 50,000 ft (15,240 m)
	LED Activity	LED Amber – Rac	
		LED Off – Radio (•
HP Integrated Module wit	h Bluetooth 4.0/4.1/4.2/5.0	0/5.1/5.2/5.3 Wire	eless Technology
	Bluetooth Specification	4.0/4.1/4.2/5.0/	5.1 Compliant/5.2/5.3 Compliant
	Frequency Band	2402 to 2480 MH	Ηz
	Number of Available	Legacy: 0~79 (1	MHz/CH)
	A I		

Number of Available Channels

BLE: 0~39 (2 MHz/CH)



Data Rates and Throughput	Legacy: 3 Mbps data rate; throughput up to 2.17 Mbps BLE: 1 Mbps data rate; throughput up to 0.2 Mbps Legacy: Synchronous Connection Oriented links up to 3, 64 kbps, voice channels Legacy: Asynchronous Connection Less links 2178.1 kbps/177.1 kbps asymmetric (3-DH5) or 864 kbps symmetric (3-EV5)
Transmit Power	The Bluetooth component shall operate as a Class II Bluetooth device with a maximum transmit power of + 4 dBm for BR and EDR.

1. Wireless access point and Internet service required and sold separately. Availability of public wireless access points limited. Wi-Fi 6 (802.11ax) is backwards compatible with prior 802.11 specs. Wi-Fi 6[™] is designed to support gigabit data rate when transferring files between two devices connected to the same router. Requires a wireless router, sold separately, that supports 80MHz and higher channels.

2. The FCC has declared as of September 1, 2014 products that utilize passive scanning on channel 12/13 and are capable of transmitting must fully comply with requirements of 15.247 or otherwise disable those channels.

3. Check latest software/driver release for updates on supported security features.

4. Receiver sensitivity is measured at a packet error rate of 8% for 802.11b (CKK modulation) and a packet error rate of 10% for 802.11a/g (OFDM modulation).

Intel® XMM™ 7560 R+ LTE-Advanced Pro¹	Technology/Operating bands	FDD LTE: 2100 (Band 1), 1900 (Band 2), 1800 (Band 3), 1700/2100 (Band 4), 850 (Band 5), 2600 (Band 7), 900 (Band 8), 700 (Band 12 lower), 700 (Band 13 upper), 700 (Band 14 upper), 700 (Band 17 lower), 850 (Band 18 lower), 850 (Band 19 upper), 800 (Band 20), 1900 (Band 25), 850 (Band 26), 700 (Band 28), 700 (Band 29 RX only), 2300 (Band 30), 1700/2100 (Band 66), 600 (band 71). TDD LTE: 2100 (Band 34), 2600 (Band 38), 1900 (Band 39), 2400 (Band 40), 2500 (Band 41), 3500 (Band 42), 3700 (Band 43), 3700 (band 48), 5200 (Band 46 RX only) MHz; HSPA+: 2100 (Band 1), 1900 (Band 2), 1700/2100 (Band 4),
		850 (Band 5), 900 (Band 8) MHz
	Wireless protocol	3GPP Release 12 LTE Specification DL-CAT.16, DL 100MHz BW
	standards	throughput up to 978Mbps; UL-CAT.13 40MHz throughput up to 150Mbps
	GPS	WCDMA R99, 3GPP Release 5, 6, 7 and 8 UMTS Specification
		Standalone GPS/Beidou/Glonass, A-GPS (MS-A, MS-B)
	GPS bands	1575.42 MHz ± 1.023 MHz, GLONASS 1596-1607MHz, Beidou 1561.098 MHz
	Maximum data rates	LTE: 978 Mbps (Download), 150 Mbps (Upload)
		DC-HSPA+: 42 Mbps (Download), 5.76 Mbps (Upload)
		HSPA+: 21Mbps (Download), 5.76 Mbps (Upload)
	Maximum output	LTE: 23 dBm in all band except B41
	, power	LTE B41 HPUE = 26dBm
	-	HSPA+: 23.5 dBm
	Maximum power	LTE: 1,200 mA (peak); 900 mA (average)
	consumption	HSPA+: 1,100 mA (peak); 800 mA (average)
	Form Factor	M.2, 3042-S3 Key B
	Weight	6 g

Technical Specifications

Dimensions (Length x Width x Thickness) eSIM 42 x 30 x 2.3 mm

Support

1. Mobile Broadband is an optional feature. Connection requires wireless data service contract, network support, and is not available in all areas. Contact service provider to determine the coverage area and availability. Connection speeds will vary due to location, environment, network conditions, and other factors. 4G LTE not available on all products or in all countries.

Realtek RTL8111HSH 10/100/1000 Integrated NIC	Ethernet Features	10 Mbit/s operation (10BASE-T; IEEE 802.3i; IEEE 802.3 clauses 13-14) 100 Mbit/s operation (100BASE-TX; IEEE 802.3u; IEEE 802.3 clauses 21- 30) 1000 Mbit/s operation (1000BASE-T; IEEE 802.3ab; IEEE 8023 clauses 40) Auto-Negotiation (Automatic Speed Selection) Full Duplex Operation at all Speeds, Half Duplex operation at 10 and 100 Mbit/s
	Power Management	ACPI compliant – multiple power modes Situation-sensitive features reduce power consumption Advanced link down power saving for reducing link down power consumption
	Performance Features	TCP/IP/UDP Checksum Offload (configurable) Protocol Offload (ARP & NS) Large send offload and Giant send offload Receiving Side Scaling Jumbo Frame 9K
	Manageability	Wake-on-LAN from modern standby or sleep state (Magic Packet and Microsoft Wake-Up Frame); Wake-on-LAN from off (Magic Packet only) PXE 2.1 Remote Boot Statistics Gathering (SNMP MIB II, Ethernet-like MIB, Ethernet MIB (802.3x, clause 30)) Comprehensive diagnostic and configuration software suite Virtual Cable Doctor for Ethernet cable status
	Interface NIC Device Driver Name	PCIe + SMBus Realtek PCIe GBE Ethernet Family Controller



POWER

AC Adapter 45 Watt	Dimensions	94.0 mm x 40.0 mm x 26.5 mm
nPFC Standard USB	Weight	192.5g +/-10%
type C Straight 1.8m	Input	100-240 VAC
	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with 115Vac/230Vac Spec: 5V: 81.5%
		9V: 86.7%
		12V: 87.41%
		15V: 87.8%
	Input frequency range	47 to 63 Hz
	Input AC current	Max. 1.4 A at 90 Vac
	Output	
	Output power	5V/15W
		9V/27W
		12V/36W
		15V/45W
	DC output	5V/9V/12V/15V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<5.0A
	Connector	USB Туре-С
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage) temperature	-4° to 185° F (-20° to 85° C)
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg.
	Certifications	*CE Mark - full compliance with LVD and EMC directives *Worldwide safety standards - IEC60950, EN60950, UL60950, Class1, SELV; Agency approvals - C-UL-US, NORDICS, DENAN, EN55022 Class B, FCC Class B, CISPR22 Class B, CCC, NOM-1 NYCE. *MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 45 Watt Smart nPFC Standard Barrel 4.5mm Right Angle 1.8m Dimensions 95 x 45 x 26.5 mm Weight unit: 200g +/- 10g Input 100-240 VAC **Input Efficiency** 87.74 % at 115 Vac and 88.4 % at 230Vac Input frequency range 47~63 Hz **Input AC current** Max. 1.4 A at 90 Vac Output **Output power** 45W **DC** output 19.5V Hold-up time 5ms at 115 Vac input



· cennear opeen		
	Output current limit	<8.0A
	Connector	4.5mm Barrel Type
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage)	-4° to 185° F (-20° to 85° C)
	temperature	
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg:
	Certifications	*CE Mark - full compliance with LVD and EMC directives
		* Worldwide safety standards - IEC60950-1 and/or IEC62368-1,
		EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1,
		Class1, SELV;
		Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC
		Class B, CISPR32 Class B, CCC, NOM-001 NYCE.
		* MTBF - over 200,000 hours at 25°C ambient condition.
AC Adapter 65 Watt	Dimensions	90.0 x 51 x 28.5mm
nPFC Standard USB	Weight	unit: 250g +/- 10g
type C Straight 1.8m	Input	100-240 VAC
	Input Efficiency	Average Efficiency of 25%, 50%, 75%, 100% load condition with
		115Vac/230Vac Spec:
		5V: 81.5%
		9V: 86.7%
		12V: 88%
		15V: 88%
		20V: 89%
	Input frequency range	47 ~ 63Hz
	Input AC current	1.6 A at 90 VAC and maximum load
	Output	
	Output power	5V/15W
		9V/27W
		12V/60W
		15V/60W
	DC output	20V/65W 5V/9V/12V/15V/20V
	-	
	Hold-up time	5ms at 115 Vac input
	Output current limit	<8.0A
	Connector	USB Type-C
	Environmental Design	
	Operating temperature	32° to 95° F (0° to 35° C)
	Non-operating (storage)	-4° to 185° F (-20° to 85° C)
	temperature	
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%



Storage Humidity	10% to 95%
Storage numbers	10% 10 93%
EMI and Safety	Eg:
Certifications	*CE Mark - full compliance with LVD and EMC directives
	* Worldwide safety standards - IEC60950-1 and/or IEC62368-1,
	EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1 ,
	Class1, SELV;
	Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC
	Class B, CISPR32 Class B, CCC, NOM-001 NYCE.
	* MTBF - over 200,000 hours at 25°C ambient condition.

AC Adapter 65 Watt	Dimensions	102x55x30mm
Smart nPFC EM Barrel	Weight	unit: 250g +/- 10g
4.5mm New EM	Input	100-240 VAC
	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230Vac
	Input frequency range	47 ~ 63 Hz
	Input AC current	Max. 1.7 A at 90 Vac
	Output	
	Output power	65W
	DC output	19.5V
	Hold-up time	5ms at 115 Vac input
	Output current limit	<11.0A
	Connector	4.5mm Barrel Type
	Environmental Design	
	Operating temperature	32°F to 95°F (0°to 35°C)
	Non-operating (storage)	-4ºF to 185ºF (-20ºto 85ºC)
	temperature	
	Altitude	0 to 16,400 ft (0 to 5000m)
	Humidity	20% to 95%
	Storage Humidity	10% to 95%
	EMI and Safety	Eg:
	Certifications	*CE Mark - full compliance with LVD and EMC directives
		* Worldwide safety standards - IEC60950-1 and/or IEC62368-1,
		EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1 ,
		Class1, SELV;
		Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC
		Class B, CISPR32 Class B, CCC, NOM-001 NYCE.
		* MTBF - over 200,000 hours at 25°C ambient condition.



rechnical Spech	ications				
AC Adapter 65 Watt	Dimensions	90 x 51 x 28.5mm			
Smart nPFC Standard	Weight	230g +/-10%			
Barrel 4.5mm Right	Input	100-240 VAC			
Angle 1.8m	Input Efficiency	88.0 % at 115 Vac and 89.0 % at 230 Vac			
	Input frequency range	47 ~ 63 Hz			
	Input AC current	Max. 1.7 A at 90 Vac			
	Output				
	Output power	65W			
	DC output	19.5V			
	Hold-up time	5 ms at 115 Vac input			
	Output current limit	<11.0A			
	Connector	4.5mm Barrel Type			
	Environmental Design				
	Operating temperature	32°F to 95°F (0°to 35°C)			
	Non-operating (storage)	-4°F to 185°F (-20°to 85°C)			
	temperature				
	Altitude	0 to 16,400 ft (0 to 5000m)			
	Humidity	20% to 95%			
	Storage Humidity	10% to 95%			
	EMI and Safety Certifications	Eg: *CE Mark - full compliance with LVD and EMC directives			
		* Worldwide safety standards - IEC60950-1 and/or IEC62368-1, EN60950-1 and/or EN62368-1, UL60950-1 and/or UL62368-1,			
		Class1, SELV;			
		Agency approvals - C-UL-US, NORDICS, DENAN, EN55032 Class B, FCC			
		Class B, CISPR32 Class B, CCC, NOM-001 NYCE. * MTBF - over 200,000 hours at 25°C ambient condition.			
RH 42Whr Long Life	Dimensions (H x W x L)	6.2 x 76.25 x 249.50 mm (0.244 x 3.002 x 9.823 inch)			
Polymer Fast Charge 3	Weight	0.18 kg (0.397 lb)			
cell Battery	Cells/Type	3cell Lithium-Ion Polymer cell / 545974			
	Energy				
	Voltage	11.4V			
	Amp-hour capacity	3.752Ah			
	Watt-hour capacity	42.75Wh			
	Temperature				
	Operating (Charging)	32° to 113° F (0° to 45° C)			
	Operating (Discharging)	14° to 122° F (-10° to 60° C)			
	Fuel Gauge LED	NA			
	Warranty				
	Optional Travel Battery	No			



Available

RH 51Whr Long Life Polymer Fast Charge 3 cell Battery	Dimensions (H x W x L) Weight Cells/Type Energy	6.50 x 67.80 x 254.00 mm (0.256 x 2.669 x 10 inch) 0.2025 kg (0.446 lb) 3cell Lithium-Ion Polymer cell / 566075
	Voltage	11.58V
	Amp-hour capacity	4.431Ah
	Watt-hour capacity	51.3Wh
	Temperature	
	Operating (Charging)	32° to 113° F (0° to 45° C)
	Operating (Discharging)	14° to 122° F (-10° to 60° C)
	Fuel Gauge LED	NA
	Warranty	
	Optional Travel Battery Available	Νο



Technical Specifications

AUDIO

HD Stereo Codec	ALC3247-CG
Audio I/O Ports	Headset: CTIA only and Headphone-out
Internal Speaker Amplifier	ALC 3247 has Embedded Class-D 2W Stereo Amplifier
Multi-streaming Capable	Playback multi-streaming can be enabled in the audio control panel to allow independent audio.
	Following MSFT Behavior
Sampling	DAC: 48kHz
	ADC: 44.1k/48kHz
Wavetable Syntheses	N/A
Analog Audio	Support 3.5mm Headset: CTIA only and Headphone-out
# of Channels on Line-Out	N/A
Internal Speaker	Yes

FINGERPRINT READER

Model: Elan efsa80ST (module P1515E)
Capacitive
508 dpi
80*80 pixels
FRR: ≤ 3%
FAR: 1:100K
Mobile Voltage Operation: 2.7V to 3.6V
-4°F – 175°F (-20° ~ +80°C)
50mA peak
900uA
30 frame/sec
+15KV
80*80 pixels/ 508 dpi / 4*4mm sensor area



ENVIRONMENTAL DATA

Eco-Label Certifications &	This product has received or is in the process of being certified to the following approvals and may					
declarations	be labeled with one or more of these marks:					
	IT ECO declaration					
	US ENERGY STAR®					
	 US Federal Energy Management Program (FEMP) EPEAT^D Gold registered in the United States. See http://www.epeat.net for registration 					
	-		see http://www.epeat.net for registration			
	status in your cou	intry.				
	TCO Certified					
	•••	servation Program (CECP)				
		onmental Protection Admini	stration (SEPA)			
	Taiwan Green Mai	rk				
	Korea Eco-label					
	Japan PC Green la					
Sustainable Impact	 Ocean-bound plastic in S 	-				
Specifications	• 15% post-consumer recy	/cled plastic				
	• Low halogen					
	-		ainably sourced and recyclable			
			inably sourced and recyclable			
	Bulk packaging available					
System Configuration	-		and Declared Noise Emissions data for the			
	Notebook model is based (on a "Typically Configured N	lotebook".			
Energy Consumption						
(in accordance with US						
(III accordance with 05						
ENERGY STAR [®] test	115846 6047	220VAC 50H-	100/00 5047			
method)	115VAC, 60Hz	230VAC, 50Hz	100VAC, 50Hz			
method) Normal Operation (Sort	115VAC, 60Hz 4.84 W	230VAC, 50Hz 5.08 W	100VAC, 50Hz 5.02 W			
method) Normal Operation (Sort idle)						
method)NormalOperationidle)NormalOperation(Long)						
method)Operation(Sortidle)NormalOperation(Longidle)	4.84 W 0.66 W	5.08 W 0.7 W	5.02 W 0.81 W			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W	5.08 W 0.7 W 0.7 W	5.02 W 0.81 W 0.81 W			
method)Operation(Sortidle)NormalOperation(Longidle)	4.84 W 0.66 W	5.08 W 0.7 W	5.02 W 0.81 W			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W	5.08 W 0.7 W 0.7 W	5.02 W 0.81 W 0.81 W			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W NOTE:	5.08 W 0.7 W 0.7 W 0.24 W	5.02 W 0.81 W 0.81 W 0.81 W 0.2 W			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data listo	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® c	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data liste family. HP computers mar	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® c ked with the ENERGY STAR®	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model ⁰ Logo are compliant with the applicable U.S.			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data listo family. HP computers mar Environmental Protection	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model Logo are compliant with the applicable U.S. R® specifications for computers. If a model			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data liste family. HP computers mar Environmental Protection family does not offer ENER	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model ⁹ Logo are compliant with the applicable U.S. R [®] specifications for computers. If a model urations, then energy efficiency data listed is			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data liste family. HP computers mar Environmental Protection family does not offer ENER for a typically configured	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu PC featuring a hard disk d	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model Logo are compliant with the applicable U.S. R® specifications for computers. If a model			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data liste family. HP computers mar Environmental Protection family does not offer ENER	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu PC featuring a hard disk d	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model ⁹ Logo are compliant with the applicable U.S. R [®] specifications for computers. If a model urations, then energy efficiency data listed is			
method)Operation(SortNormalOperation(LongNormalOperationLongidle)Sleep	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data liste family. HP computers mar Environmental Protection family does not offer ENER for a typically configured	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu PC featuring a hard disk d	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model ⁹ Logo are compliant with the applicable U.S. R [®] specifications for computers. If a model urations, then energy efficiency data listed is			
method)Operation(SortNormalOperation(Longidle)SleepOff	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data lister family. HP computers mar Environmental Protection family does not offer ENER for a typically configured Microsoft Windows® opera	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu PC featuring a hard disk d ating system.	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model ⁰ Logo are compliant with the applicable U.S. R [®] specifications for computers. If a model urations, then energy efficiency data listed is lrive, a high efficiency power supply, and a			
method)Operation(SortNormalOperation(Longidle)SleepOffHeat Dissipation*	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data lister family. HP computers mar Environmental Protection family does not offer ENER for a typically configured Microsoft Windows® opera	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu PC featuring a hard disk d ating system.	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model ⁰ Logo are compliant with the applicable U.S. R [®] specifications for computers. If a model urations, then energy efficiency data listed is lrive, a high efficiency power supply, and a			
method)Operation(SortNormalOperation(Longidle)SleepOffNormalNormalNormalNormalBeepOffSleepOffSleepOffSleepOffSleepSleepOffSleepSleepOffSleep <td< th=""><th>4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data listo family. HP computers mar Environmental Protection family does not offer ENEF for a typically configured Microsoft Windows® operations 115VAC, 60Hz</th><th>5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu PC featuring a hard disk d ating system. 230VAC, 50Hz</th><th>5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model 0.2 W 0.2 W New specifications for computers. If a model urations, then energy efficiency data listed is live, a high efficiency power supply, and a 100VAC, 50Hz</th></td<>	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data listo family. HP computers mar Environmental Protection family does not offer ENEF for a typically configured Microsoft Windows® operations 115VAC, 60Hz	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu PC featuring a hard disk d ating system. 230VAC, 50Hz	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model 0.2 W 0.2 W New specifications for computers. If a model urations, then energy efficiency data listed is live, a high efficiency power supply, and a 100VAC, 50Hz			
method)Operation(SortNormalOperation(Longidle)SleepOffOffHeat Dissipation*NormalOperation(Shortidle)NormalOperation(Short	4.84 W 0.66 W 0.66 W 0.2 W NOTE: Energy efficiency data listo family. HP computers mar Environmental Protection family does not offer ENEF for a typically configured Microsoft Windows® operations 115VAC, 60Hz	5.08 W 0.7 W 0.7 W 0.24 W ed is for an ENERGY STAR® co ked with the ENERGY STAR® Agency (EPA) ENERGY STA RGY STAR® compliant configu PC featuring a hard disk d ating system. 230VAC, 50Hz	5.02 W 0.81 W 0.81 W 0.2 W ompliant product if offered within the model 0.2 W 0.2 W New specifications for computers. If a model urations, then energy efficiency data listed is live, a high efficiency power supply, and a 100VAC, 50Hz			



Off	0.7 BT	BTU/hr 0.8 BTU/hr			0.7 BTU/hr	
	* NOTE: Heat dissipation is calculated based on the measured watts, assuming the service level attained for one hour.					
Declared Noise Emissions	Sound Power Sound Pressure					
(in accordance with		(Lwad, bels)		(L _{pAm} , de		
ISO 7779 and ISO 9296)				(Liphin) ac		
Typically Configured – Idle		2.2		13	.6	
Fixed Disk – Random writes		2.4		18	.4	
Optical Drive – Sequential reads		3.0		28.	.0	
Longevity and Upgrading	This product can be upgraded, possibly extending its useful life by several years. Upgradeable features and/or components contained in the spare parts are available throughout the warranty period and or for up to "5" years after the end of production					
Additional Information	 This product is in compliance with the Restrictions of Hazardous Substances (RoHS) directive - 2011/65/EC. This HP product is designed to comply with the Waste Electrical and Electronic Equipment (WEEE) Directive - 2002/96/EC. This product is in compliance with California Proposition 65 (State of California; Safe Drinking Water and Toxic Enforcement Act of 1986). This product is in compliance with the IEEE 1680 (EPEAT) standard at the Gold level, see www.epeat.net Plastics parts weighing over 25 grams used in the product are marked per IS011469 and IS01043. This product is 93.2% recycle-able when properly disposed of at end of life. 					
Packaging Materials	External:	ernal: PAPER/Corrugated			230 g	
		PAPER/Pape	erboard		51 g	
		PAPER/Molo	led Pulp		122 g	
	Internal:	iternal: PLASTIC/Polyethylene low density - LDPE		- LDPE	9 g	
	The plastic packaging material contains at least 0.0% recycled content.				t.	
	The corrugated paper packaging materials contains at least 57% recycled content.					
RoHS Compliance	The corrugated paper packaging materials contains at least 57% recycled content. HP Inc. complies fully with materials regulations. We were among the first companies to extend the restrictions in the European Union (EU) Restriction of Hazardous Substances (RoHS) Directive to our products worldwide through the HP GSE. HP has contributed to the development of related legislation in Europe, as well as China, India, and Vietnam. We believe the RoHS directive and similar laws play an important role in promoting industry-wide elimination of substances of concern. We have supported the inclusion of additional substances— including PVC, BFRs, and certain phthalates—in future RoHS legislation that pertains to electrical and electronics products. We met our voluntary objective to achieve worldwide compliance with the new EU RoHS requirements for virtually all relevant products by July 2013, and we will continue to extend the scope of the commitment to include further restricted substances as regulations continue to evolve. To obtain a copy of the HP RoHS Compliance Statement, see HP RoHS position statement.					



Material Usage	This product does not contain any of the following substances in excess of regulatory limits (refer
	to the HP General Specification for the Environment at
	http://www.hp.com/hpinfo/globalcitizenship/environment/supplychain/gen_specifications.html)
	: A Ashestos
	Asbestos Certain Azo Colorants
	 Certain Brominated Flame Retardants – may not be used as flame retardants in plastics Cadmium
	Cadmium Chlorinated Hudrocarbons
	 Chlorinated Hydrocarbons Chlorinated Paraffins
	 Bis(2-Ethylhexyl) phthalate (DEHP) Benzyl butyl phthalate (BBP)
	 Dibutyl phthalate (DBP)
	 Disobutyl phthalate (DBP) Disobutyl phthalate (DIBP)
	Formaldehyde
	Halogenated Diphenyl Methanes
	Lead carbonates and sulfates
	Lead and Lead compounds
	Mercuric Oxide Batteries
	 Nickel – finishes must not be used on the external surface designed to be frequently
	handled or carried by the user.
	Ozone Depleting Substances
	Polybrominated Biphenyls (PBBs)
	Polybrominated Biphenyl Ethers (PBBEs)
	Polybrominated Biphenyl Oxides (PBBOs)
	Polychlorinated Biphenyl (PCB)
	Polychlorinated Terphenyls (PCT)
	• Polyvinyl Chloride (PVC) – except for wires and cables, and certain retail packaging has
	been voluntarily removed from most applications.
	Radioactive Substances
	• Tributyl Tin (TBT), Triphenyl Tin (TPT), Tributyl Tin Oxide (TBTO)
Packaging Usage	HP follows these guidelines to decrease the environmental impact of product packaging:
	Eliminate the use of heavy metals such as lead, chromium, mercury and cadmium in
	packaging materials.
	Eliminate the use of ozone-depleting substances (ODS) in packaging materials.
	 Design packaging materials for ease of disassembly. Maximize the use of post-consumer recycled content materials in packaging materials.
	 Maximize the use of post-consumer recycled content materials in packaging materials. Use readily recyclable packaging materials such as paper and corrugated materials.
	 Reduce size and weight of packages to improve transportation fuel efficiency.
	 Plastic packaging materials are marked according to ISO 11469 and DIN 6120 standards.
End-of-life Management	HP offers end-of-life HP product return and recycling programs in many geographic areas. To
and Recycling	recycle your product, please go to: http://www.hp.com/go/reuse-recycle or contact your nearest
	HP sales office. Products returned to HP will be recycled, recovered or disposed of in a responsible
	manner.



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Technical Specifications

		The EU WEEE directive (2002/95/EC) requires manufacturers to provide treatment information for each product type for use by treatment facilities. This information (product disassembly instructions) is posted on the Hewlett Packard web site at: http://www.hp.com/go/recyclers. These instructions may be used by recyclers and other WEEE treatment facilities as well as HP OEM customers who integrate and re-sell HP equipment.
HP, Inc.	Corporate	For more information about HP's commitment to the environment:
Environmental		
Information		Global Citizenship Report
		http://www.hp.com/hpinfo/globalcitizenship/gcreport/index.html
		Eco-label certifications
		http://www8.hp.com/us/en/hp-information/environment/ecolabels.html ISO 14001 certificates:
		http://h20195.www2.hp.com/V2/GetDocument.aspx?docname=c04755842 and
		http://www.hp.com/hpinfo/globalcitizenship/environment/pdf/cert.pdf
footnotes		Percentage of ocean-bound plastic contained in each component varies by product
		 Recycled plastic content percentage is based on the definition set in the IEEE 1680.1- 2018 standard.
		• External power supplies, WWAN modules, power cords, cables and peripherals excluded.
		• 100% outer box packaging and corrugated cushions made from sustainably sourced certified and recycled fibers.
		• Fiber cushions made from 100% recycled wood fiber and organic materials.

COUNTRY OF ORIGIN

China

Options and Accessories (sold separately and availability may vary by country)

DOCKING (Cold Constalu)	
DOCKING (Sold Separately) Docking station model #1	HP Thunderbolt Dock G2
-	HP Thunderboll Dock G2
Total number of supported displays (incl. the notebook display)	4
Max. resolutions supported	Dual 4K @30Hz or dual 4K UHD @ 60Hz is supported ⁹
	Single 8K@ 60Hz for Thunderbolt hosts or USB-C hosts DP 1.4 with DSC in high-res mode.
Dock Connectors	2xDP, 1xVGA, 1xTB, 1xUSB-C alt-mode
Technical limitations	Thunderbolt Hosts:
	Maximum of (4) displays with maximum resolution of 5K@ 30Hz running Thunderbolt host.
	Maximum resolution possible is dual 8K displays @ 60Hz running Thunderbolt host or running a non-Thunderbolt host in high resolution mode @30Hz Non-Thunderbolt hosts:
	The highest resolution for dual displays running a non-Thunderbolt host in multi-function mode is
	(1) 5K dual cable (using both DP ports) +(1) 4K on USB-C DP port
	Non-Thunderbolt hosts support (3) displays with a maximum resolution of (2) 5K single cable + (1) 4K UHD @ 60 Hz in high resolution mode. In multi- function mode the maximum resolution for (3) displays is (2) 5K single cable @ 30Hz + (1) 4K UHD @ 30Hz.
Docking station model #2	HP USB-C Dock G5
Total number of supported displays (incl. the notebook display)	3
Max. resolutions supported	Dual 5K@ 30Hz + 1 4K UHD (multi-function mode) 5120 x 2880 ⁹ Highest resolution with dual displays is two 8K@ 60Hz host in High Resolution mode.
Dock Connectors	1xHDMI, 2xDP
Technical limitations	The highest resolution for running a non-Thunderbolt host in multi-function mode is a single 5K dual cable (using both DP ports) + one 4K on HDMI port.
Docking station model #3	HP USB-C/A Universal Dock G2
Total number of supported displays (incl. the notebook display)	3
Max. resolutions supported	Triple 4K UHD@ 60Hz 3840 x 2160 ⁹
Dock Connectors	1xHDMI, 2xDP
Technical limitations	The best resolution for dual or triple displays is 4K UHD@ 60Hz. For use with the USB-A adapter that comes in the box the maximum number of displays supported is (2) 4k x 60 Hz on the Type-A Gen 1 connection from the host



Options and Accessories (sold separately and availability may vary by country)

Category	Description	Part Number
Audio/Video	HP Wired USB-A Stereo Headset	428K6AA
	HP Wired 3.5mm Stereo Headset	428K7AA
Cases	HP Business 14.1 Sleeve	2UW01AA
	HP Business Slim 17.3 Top Load	2UW02AA
	HP Executive 14.1 Tote	6KD10AA
	HP Executive 15.6 Backpack	6KD07AA
	HP Executive 15.6 Top Load	6KD06AA
	HP Executive 17.3 Backpack	6KD05AA
	HP Executive 17.3 Top Load	6KD08AA
	HP Executive Leather 15.6 Top Load	6KD09AA
	HP Executive Slim 14.1 Top Load	6KD04AA
	HP Prelude G2 15.6 Backpack	1E7D6AA
	HP Prelude G2 15.6 Top Load	1E7D7AA
	HP Prelude Pro Recycled 15.6 Backpack	1X644AA
	HP Prelude Pro Recycled 15.6 Top Load	1X645AA
	HP Renew 14 Laptop Sleeve	2E6U9AA,2E6V0AA
	HP Renew Business 14.1 Laptop Bag	ЗЕ5Ғ9АА
	HP Renew Business 14.1 Laptop Sleeve	3E2U7AA
	HP Renew Business 17.3 Laptop Backpack	3E2U5AA
	HP Renew Business 17.3 Laptop Bag	3E2U6AA
	HP Renew Business 15.6 Laptop Bag	3E5F8AA
Docking	HP Thunderbolt 120W G2 Dock	2UK37AA
	HP Thunderbolt 120W G2 Dock w/Audio	3YE87AA
	HP Thunderbolt 120W G4 Dock	4JOAZAA
	HP Thunderbolt 230W G2 Dock w/Combo Cable	3TR87AA
	HP Thunderbolt 280W G4 Dock w/Combo Cable	4JOG4AA
	HP USB-C/A 120W G2 Universal Dock	5TW13AA
	HP USB-C 120W G5 Dock	26D32AA
Hub	HP USB-C Mini Dock	1PM64AA
	HP Universal USB-C Multiport Hub	50H55AA
	HP USB-C Travel Dock G2	7PJ38AA
	HP USB-C to USB-A Hub	Z6A00AA
Adapter	HP HDMI to DVI Adapter	F5A28AA
	HP HDMI to VGA Adapter	H4F02AA
	HP USB-C to DisplayPort Adapter	N9K78AA
	HP USB-C to HDMI 2.0 Adapter	1WC36AA
	HP USB-C to USB 3.0 Adapter	N2Z63AA
	HP USB-C to VGA Adapter	N9K76AA



Options and Accessories (sold separately and availability may vary by country)

•		3 •
Keyboard/Combo	HP 975 USB+BT Dual-Mode Wireless Keyboard	3Z726AA
	HP 455 Programmable Wireless Keyboard	4R177AA
	HP 125 WD USB Keyboard	266C9AA
	HP 320K WD USB Keyboard	9SR37AA
	HP 655 Wireless Keyboard and Mouse Combo	4R009AA
	HP 225 Wired Mouse and Keyboard Combo	286J4AA
	HP 235 Wireless Mouse and Keyboard Combo	1Y4D0AA
	HP Slim Wireless Keyboard and Mouse	T6L04AA
	HP Wired Desktop 320MK Mouse and Keyboard	9SR36AA
	HP Wireless Rechargeable 950MK Mouse and Keyboard	3M165AA
Mouse	HP USB Premium Wireless Mouse	1JR31AA
	HP 435 Multi-Device Wireless Mouse	3B4Q5AA
	HP 125 USB-A Wired Mouse	265A9AA
	HP 128 USB Laser Wired Mouse	265D9AA
	HP 320M USB-A Wired Mouse	9VA80AA
	HP Creator USB-A+Bluetooth 935 Wireless Mouse Black	1DOK8AA
	HP USB-A+Bluetooth Multi-Device 635 Wireless Mouse Black	1D0K2AA
	HP USB-A+Bluetooth Travel Bluetooth Mouse	6SP30AA
Power	HP 65W USB-C Auto Chevy AC Power Adapter	5TQ76AA
	HP 45W 4.5 mm Smart AC Power Adapter	H6Y88AA
	HP 45W USB-C G2 Zeus AC Power Adapter	1HE07AA
	HP 45W USB-C LC Dali AC Power Adapter	1MZ01AA
	HP 65W 4.5 mm LC Smart non-EM India Ony AC Power Adapter	3FF84AA#ACJ
	HP 65W 4.5 mm Smart AC Power Adapter	H6Y89AA
	HP 65W 4.5 mm wDongle 7.4 mm Slim AC Power Adapter	H6Y82AA
	HP 65W USB-C Hades AC Power Adapter	1HE08AA
	HP 65W USB-C LC AC Power Adapter	1P3K6AA
Commodity	HP USB DVD-Writer EXT ODD	F2B56AA
	HP Nano Keyed Cable Lock	1AJ39AA
	HP Nano Master Keyed Cable Lock	1AJ40AA
	HP SureKey Standard/Nano/Wedge Cable Lock	6UW42AA



Summary of Changes

Date of change:	Version History:	Updated	Description of change:
January 25, 2022	V1 to V2	Added	TPM and IPv6 Compliance in Security section and Battery Life
February 11, 2022	V2 to V3	Removed	Tile App from Software and Security section
February 15, 2022	V3 to V4	Updated	Display Port in Ports and Slots section
February 22, 2022	V4 to V5	Updated	WWAN Module and Battery Life section
February 28, 2022	V5 to V6	Removed	HP 955 4K Webcam from Accessories; add Wake on WLAN
March 14, 2022	V6 to V7	Added	Battery Compliance in Power section
April 11, 2022	V7 to V8	Added	Reference for USB ports
July 19, 2022	V8 to V9	Added	Input value in Power section
October 20, 2022	V9 to V10	Updated	Bluetooth version
December 8, 2022	V10 to V11	Updated	Windows OS
January 12, 2023	V11 to V12	Added	HP Client Security Manager in Software and Security section
January 20, 2023	V12 to V13	Updated	Operating System

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